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HIGH STRENGTH FOAM TOOL AND METHOD

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HIGH STRENGTH FOAM TOOL AND METHOD

STATEMENT OF GOVERNMENT INTEREST

[0001] This invention was made with Government support under government contract no. DE – AC04 – 94AL85000 awarded by the U.S. Department of Energy to Sandia Corporation. The Government has certain rights in the invention, including a paid-up license and the right, in limited circumstances, to require the owner of any patent issuing in this invention to license others on reasonable terms.

BACKGROUND OF THE INVENTION

FIELD OF THE INVENTION

[0002] This invention generally relates to development of tooling for composite manufacture and as tooling for injection molding and hot embossing of polymers. In particular, the invention relates to methods for providing improved prototyping tools for construction of composite manufacturing and as tooling for injection molding and hot embossing of polymers. More particularly, the present invention relates to a syntactic foam composition for providing robust, reusable tooling.

PRIOR ART

[0003] As greater emphasis is placed on design and manufacture of complex light-weight composite structures, methods for quickly and inexpensively prototyping those structures have been sought. One method is the use of wax molds to prepare a casing having the shape or surface features that a manufacturer desires to render in a composite structure. In particular, Shape Deposition Manufacturing (SDM) technology comprises fabrication of parts by the sequential deposition, solidification, and precision CNC machining of wax layers, which are deposited upon one another until a desired product mold results (see for example, U.S. Patent Serial Nos. 6,508,971; 6,342,541; 6,259,962; and 5,301,415). A liquid resin (i.e., polyurethane, epoxy, or ceramic gel-casting slurry) can then be cast into the wax or plastic mold and cured to produce the desired part.

[0004] Unfortunately, many of the materials currently used to replicate the molds tend either to be fragile or difficult to use. The problematic nature of these materials make it difficult to prepare and produce usable lay-up tools. Moreover, many materials will not survive the elevated temperatures necessary to cure the resins used in traditional composite manufacturing. To a large extent the selection of the best choice of materials is determined by the nature of the molding technique, the environment to which the mold will be subjected, and an evaluation of the cost of materials, which have acceptable characteristics.

[0005] The present invention, therefore, is directed to the suitability of a category of materials referred to as syntactic foams. In particular, embodiments of the invention comprising specifically modified syntactic foam-filled materials, have been found to be highly suitable for preparing mold prototypes, particularly those which are, or which are likely to be, subjected to relatively high temperatures during processing.

SUMMARY OF THE INVENTION

[0006] An embodiment of the present invention, therefore, relates to a robust, high strength polymer foam that is stable at elevated temperatures and capable of routine assembly and handling without significant damage or breakage.

[0007] More particularly, it is an object of this invention to provide polymer foams comprising a glass microsphere "filled" syntactic foam created by the reaction between an epoxy resin and isocyanate and an amine catalyst.

[0008] Another object of these embodiments is to provide a moldable polymer foam member capable of sustaining process temperatures above 177°C (350°F).

[0009] Yet another object of these embodiments is to provide a moldable polymer foam member capable of being prepared in thickness in excess of about 50 millimeters (2 inches).

[0010] Still other objects and advantages of the present invention will be ascertained from a reading of the following detailed description and the appended claims.

BRIEF DESCRIPTION OF THE DRAWINGS

- [0011] *Figure 1* illustrates the formation of an oxizolidinone by combining an isocyanate and an epoxide.
- [0012] *Figure 2* illustrates the formation of a cyclic isocyanurate by a trimerization reaction of an isocyanate.
- [0013] *Figure 3* illustrates the effect on the density of TEPIC foam that results from the addition of small amounts of water to the precursor constituent mixture.
- [0014] *Figure 4* shows a photographic picture of a cutaway of a molded block of TEPIC foam illustrating the interior conformation of this material.
- [0015] *Figure 5* shows an SEM image of a fracture surface of the TEPIC foam.
- [0016] *Figure 6A* shows a block of TEPIC in the process of being machined with a fly cut tool on a milling machine.
- [0017] *Figure 6B* shows a hollow cylinder of TEPIC and a part machined from a similar cylindrical part.
- [0018] *Figure 7* illustrates the thermal expansion of the TEPIC polymer foam as it is heated from room temperature to about 200°C with the slope being the coefficient of thermal expansion (CTE).
- [0019] *Figure 8* illustrates the quasi-static uniaxial compression data for the standard TEPIC formulation with a density of 0.63 g/cm³.
- [0020] *Figure 9* illustrates a method for molding a hollow TEPIC part.

DETAILED DESCRIPTION OF THE INVENTION

[0021] Composites are traditionally cured at two temperatures: 120°C and 175°C (250°F and 350°F). Specialized materials are needed to provide tooling for composite structure. The tooling must act as both a support and replicating surface for these structures. At the same time, they must remain dimensionally stable at elevated temperatures during the resin cure process for the composite materials. A moldable fibrous material having the trade name Aquacore® made by the Advanced

Ceramics Research Company (Tucson, AZ) and a machinable polyurethane stock product having the trade name Polyboard[®] made by Ciba Specialty Chemicals, Inc., (Basel, Switzerland), are examples of two materials in current use. Both of these materials, however, exhibit some characteristics that limit their usefulness as effective materials for providing composite lay-up tooling. In particular, when used with a wax mold, Aquacore[®] requires many hours or days (depending on the part thickness) to dry since it cannot be heated above the wax stump temperature. Furthermore, this material tends to crack during drying and the end material has been found to be brittle, weak and friable. Alternately, Polyboard[®] must be machined to shape and because it is most commonly produced as a 2" thick stock sheet, lay-up tool shapes requiring thicker cross sections necessitate gluing multiple boards together. Unfortunately, due to the heating cycle through which the composite materials must be subjected, the "joined" Polyboard sections often debond during processing.

[0022] A structure resembling a traditional rigid polyurethane foam is desired since a continuous resin phase is known to have superior mechanical properties and machineability characteristics. To achieve this result, an approach that combines chemistries known to form thermally stable products is considered. The principal constituents are an oxizolidinone produced by the reaction of an isocyanate with an epoxide (*Figure 1*), and a cyclic isocyanurate formed by the trimerization of an isocyanate (*Figure 2*).

[0023] As these constituents are mixed some air is mechanically incorporated into the liquid. Additionally, a light-weight, non-reactive bulk filler is added to increase the modulus and reduce the density of the of the subsequently expanded polymer body. Optionally, a small amount of water also may be directly added to the mixture in order to further reduce the density of the polymer in those cases that require a lower density (for example, in applications where weight or thermal conductivity is important). Furthermore, water may be introduced indirectly as water absorbed to the surface of the filler additive.

[0024] The high temperature structural foam produced by these materials is referred to hereinafter as “*TEPIC*,” an acronym for “*The Epoxy PolyIsoCyanurate*” polymer foam. The reactants used in processing *TEPIC* are listed in *Table 1*. The specific quantities listed yield a free rise density of about 0.4 g/cm³. These chemicals were used as supplied without further purification.

TABLE 1 CHEMICALS, AMOUNTS, AND MANUFACTURERS USED IN PREPARATION OF *TEPIC* FOAMS.

<u><i>Chemical</i></u>	<u><i>Amount</i></u> <u><i>(g)</i></u>	<u><i>Chemical Producer/Supplier</i></u>
EPON [®] 826 Epoxy Resin*	129.6	Resolution Performance Products
PAPI [®] 94 Isocyanate Resin	243.0	Dow Chemical
DABCO [®] DC193 Surfactant	16.2	Air Products
SCOTCHLITE [®] D32/4500 GMB	60.0	3M
DABCO [®] TMR-30 Catalyst	0.9	Air Products
POLYCAT [®] 8 Catalyst	0.3	Air Products
DI Water (optional)	0.23	n/a

* resin weight may comprise up to about 50% CTBN polymer

[0025] *TEPIC* foam is processed in a manner similar to traditional rigid polyurethane foams. Each of the reactants is added sequentially, and hand stirred using a metal spatula. First, an epoxy resin (EPON[®] 826 manufactured by Resolution Performance Products, LLC) formed by a condensation reaction of bisphenol A (4,4'-isopropylidenediphenol) and epichlorohydrin (1-chloro-2,3-epoxypropane), is mixed together with a surfactant (DC193[®]), and water (when included) in a 4 liter container (for the quantities listed in *Table 1*). Epoxies that may be suitably substituted for EPON[®] 826 include those prepared with bisphenol F (4',4'-methylenediphenol) rather than with bisphenol A. Moreover, carboxyl-terminated butadiene acrylonitrile (CTBN) polymer additives may be included in the epoxide resin as a toughening

agent in amounts up to about 50 weight percent of the epoxide/CTBN polymer mixture.

[0026] Once this initial mixing is completed, an isocyanate mixture comprising diphenylmethane diisocyanate, methylene bisphenyl isocyanate, and polymethylene polyphenyl isocyanate (PAPI[®] 94 manufactured by Dow Chemical Company) is stirred into the epoxide mixture, followed by a quantity of a light-weight, non-reactive bulk filler material such as hollow glass microspheres, sometimes referred to as “GMB” or glass microballoons[®]. Filler materials are added primarily as toughening agents and as viscosity modifiers to thicken the mixture and to control and uniformly distribute the formation of pores in the mixture as it reacts with water (as an impurity or intentionally added) to produce CO₂. The filler may be eliminated of course which results in a low viscosity precursor mixture that allows any CO₂ that is formed to quickly rise through the mixture and either escape or coalesce at the top of the mixture and yield a high density free-rise part. As seen in *Figure 3* small additional amounts of water, therefore, added directly into the pre-rise mixture can control the density of those TEPIC polymer parts in which a filler is added.

[0027] While the particular filler material used in the present formulation is a 3M[®] product identified by the trade name SCOTCHLITE[®] D32/4500, other material fillers/viscosity modifiers would be equally effective. Equivalent materials would include, but are not limited to, other classes of glass microsphere (Scotchlite[®] A15/500, K46, and S60/10,000) or MicroBalloons[®] (Shell Chemical); glass-ceramic cenospheres (coal combustion fly ash) such as are available from AshTek, or from Trelleborg Fillite Inc. (FILLITE[®]); multi-cellular glass microspheres available from Grefco Minerals, Inc. (Dicaperl); polymeric microspheres; Cab-O-Sil[®] (submicron “fumed” silicon dioxide particles manufactured by Cabot Industries); comminuted mica, or beta eucryptite, and the like, are also useful as non-reactive, bulk fillers. In addition, various “chopped” or loose man-made fibers such as glass fibers (s-glass, e-glass), carbon fiber, and aramid fibers such as KEVLAR[®] (poly(p-phenyleneterephthalamide), manufactured by E.I. duPont de Nemours and Company, Wilmington, DE) and similar equivalent materials, may be added to the foregoing bulk fillers in amounts varying from 0.3 weight percent to about 5 weight percent.

[0028] Filler materials can be difficult to fully incorporate and disperse into liquid mixes. Satisfactory incorporation of the filler and the liquid reactants is achieved by thorough mixing with a 4-inch CONN[®] blade for 3 to 5 minutes. Periodically, the sides of the container were scraped with a spatula to help further disperse the filler.

[0029] Lastly, a small quantity of two catalysts: a tertiary amine such as 2,4,6-tris(dimethylaminomethyl)phenol (DABCO[®] TMR-30 manufactured by Air Products and Chemical, Inc.) and a cyclic amine such as N,N-dimethylcyclohexylamine (POLYCAT[®] 8 manufactured by Air Products and Chemical, Inc.), is added to the other liquid reactants and again mixed with the CONN[®] blade for about an additional 45 seconds.

[0030] This mixture is then poured into a mold that had been coated with a release agent or wax and the mixed liquid allowed to gel and rise at room temperature over the next hour. The mold is then cured in a forced-air oven at set at 65°C overnight.

[0031] Because the foam requires strength above ambient temperatures, an additional curing step is used to increase the T_g (glass transition temperature) of the cured polymer. To this end, the foam is removed from the mold and heated with a gradual ramp to 200°C over 28 hours. The foam is then held for 5 hours before slowly being cooled to room temperature.

[0032] The processing conditions described above and the formulation listed in *Table 1* yields a foam having a free-rise density of about 0.4 g/cm³. It was found that the quantity of water used in the formulation had a dramatic effect on the density of the foam as is shown in *Figure 3*. It was also found that the particular combination of catalysts used in this composition was instrumental in producing a workable product having the desired density, pore size and mechanical strength. A prior formulation using only the tertiary amine catalyst TMR-3 was found to react much too quickly when water was used. This formulation produced a foam that rose rapidly and then collapsed in upon itself. Many other isocyanate trimerization agents were investigated but none could be found that would yield both an acceptable product and exhibit acceptable processing characteristics. Moreover, with the exception of TMR-30 none of the other catalysts was stable in the presence of water. However,

TMR-30 alone did not provide the desired uniform pore structure probably due to its rapid reaction time when water was present.

[0033] It was discovered, therefore, that when the cyclic amine POLYCAT[®] 8 was added to formulations prepared with TMR-30 the desired balance between the various polymerization reactions and the gas generation reaction was achieved. The result was a foam gel with a stable cell structure that also possessed forgiving enough processing characteristics to allow manual mixing and molding.

[0034] The processing steps used for making *TEPIC* foam parts are summarized and listed below. The steps comprise:

- 1.) *Adding surfactant (and DI water, if used) to epoxy resin – Hand stir;*
- 2.) *Adding isocyanate resin to the epoxy/surfactant mixture – Hand stir;*
- 3.) *Adding the bulk filler to the epoxy/surfactant/isocyanate mixture – Mixing thoroughly with a CONN[®] blade for at least 1 minute;*
- 4.) *Adding a requisite quantity of TMR-30[®] and POLYCAT[®] 8 to the epoxy/surfactant/isocyanate/filler mixture – Mixing for about an additional 45 seconds with a CONN[®] blade;*
- 5.) *Pouring the mixed liquid into a mold;*
- 6.) *Allowing the mixed liquid to remain undisturbed at ambient temperature for at least 1 hour in order to gel;*
- 7.) *Heating the mold and contents in a forced air oven set at 65°C ± 5°C for about 12 to 16 hours to cure the gelled liquid;*
- 8.) *Removing the mold from the oven and demolding the reacted foam part;*
- 9.) *Cleaning the surface of the foam part by thoroughly wiping it with acetone; and*
- 10.) *Post-curing the foam part to 200°C with the following temperature profile:*
 - *returning the foam part to the 65°C oven for 2 hours;*
 - *ramping the temperature of the oven up to 150°C over 8 hours and hold at this temperature for an additional 5 hours;*
 - *ramping the temperature of the oven up to 180°C over 8 hours and hold at this temperature for an additional 5 hours;*

- *ramping the temperature of the oven up to 200°C over 5 hours and hold at this temperature for an additional 5 hours; and*
- *ramping the temperature of the oven down to 65°C over 5 hours and hold at this temperature for an additional 1 hour.*

[0035] The time interval between Steps 5 and 6 should be less than 2 minutes since the mix will start to gel in the mixing container if it is not transferred into the mold fast enough.

[0036] During the post-cure cycle, Step 10, the actual ramp rate will vary depending on the characteristic part dimension. Parts with thicker cross-sectional dimensions will require slower ramp rates in order to avoid charring. For example, the ramp rate called out in Step 10 was optimized for parts with maximum thicknesses of about 10 centimeters (about 4"), and while part cross sections greater than 10 cm are well within the scope of this invention, at some point the required ramp rates will be so slow as to render the process impractical. For example, a ramp to 200°C over the course of 4 days was used for a 30 cm diameter by approximately 50 cm tall cylinder of TEPIIC.

[0037] When prepared as described above, the resultant foam body exhibits an exterior "skin" having a caramel-brown appearance which extends inward less than a millimeter to reveal a core characterized as having an even distribution of fine pores (*Figure 4*). This core region is further characterized as having a buff, cream colored appearance. An SEM photomicrograph of a typical fracture surface of the foam structure (*Figure 5*) shows the polymer matrix strongly adhering to the GMB filler.

[0038] The material is also shown to machine cut easily and uniformly, much like phenolic. However, the TEPIIC foam is abrasive because of the presence of the filler and machining is aided by the use of carbide or diamond tools to avoid excessive wear. *Figure 6A* shows the surface of a sheet of the foam after it has been "planed" by fly-cutting with the tool that appears in the foreground. *Figure 6B* shows a large cylinder of TEPIIC before machining and a similar piece after being cut into the hollow, tapered cylinder shown. The finished polymer, therefore, is readily shaped

either by direct molding or by milling or cutting the desired shape into the surfaces of a cast foam part. Furthermore, various coating products have been found to be effective in those situations where surface machining is called for but where a high gloss finish is necessary for a particular application. In particular, Dura Technologies Inc. Bloomington, CA manufactures polyester/styrene monomer primers (e.g. 702-003, 707-002, or 714-002) and coatings (602-021, 608-021, or 614-021) under the trade name Duratec®; and Dexter Aerospace, Pittsburg, CA, (a division of the Henkel Loctite Corporation) manufactures a two-part amine cured epoxy resin (EA9396) under the trade name of Hysol®. These materials have been applied as a surface treatment on freshly milled TEPIC parts to provide a smooth, hard and void-free surface. Parts were treated in this way to aids in the release of parts prepared using the cured TEPIC as a mold.

EXAMPLES

[0039] The following examples are provided as a way to better describe the present invention. Each includes the formulation used to prepare the polyisocyanurate foam body. Samples tested over a range of densities from 0.3 g/cm³ to about 0.8 grams/cm³ of about 0.4 g/cm³ were prepared. The present invention is not restricted to these densities alone, but was selected for convenience only in order to provide a baseline for comparison.

[0040] The general formulation for providing the low density polyisocyanurate foam of the present invention is shown above. Several variations of this general formula, however, have been found to be suitable. In particular, foam samples were produced using a variety of different filler materials and a variety of different epoxies (with and without an elastomeric additive) so as to determine the effect of changing the formulation on density and on compression strength, especially at elevated temperatures. The TEPIC formulations used to produce these test specimen are shown below in *Tables 2A* and *2B*.

TABLE 2A
VARIOUS *TEPIC* FORMULATIONS
SINGLE EPOXY CONSTITUENT

SAMPLE ID	002	013	023	024a	024c	030	155
CONSTITUENTS	MASS (GRAMS)	MASS (GRAMS)	MASS (GRAMS)	MASS (GRAMS)	MASS (GRAMS)	MASS (GRAMS)	MASS (GRAMS)
PAPI 2094	488.70	243.59	243.22	250.43	121.52	255.00	485.90
TMR-30	2.26	1.12	1.16	1.18	0.56	1.13	2.26
Polycat 8	0.91	0.46	0.45	0.45	0.25	0.45	0.94
DC 193	35.3	16.46	16.28	16.24	8.24	16.26	32.35
SUBTOTAL CONSTITUENTS	527.17	261.63	261.11	268.30	130.57	272.84	
<u>Epoxies</u>							
EPON 826	267.21		130.06	130.37	65.87	132.63	258.36
EPON 8280		130.98					
EPON 826 +10% CTBN							
EPON 58005+10% CTBN							
EPON 58006+10% CTBN							
EPON 58034+10% CTBN							
EPON 58042+10% CTBN							
SUBTOTAL EPOXY	267.21	130.98	130.06	130.37	65.87	132.63	258.36
TOTAL REACTANTS	794.38	392.61	391.17	398.67	196.44	405.47	
<u>Fillers</u>							
GMB A16/500			48.28				
GMB D32/4500		48.3					96.00
GMB K46						48.85	
Dicaperl HP 910					24.02		
Fillite 300LF	96.41			62.65			

TABLE 2B
VARIOUS *TEPIC* FORMULATIONS
CTBN MODIFIED EPOXY CONSTITUENTS

SAMPLE ID.	005	038	039	040	041	042	043
CONSTITUENTS	QTY	MASS (GRAMS)	MASS (GRAMS)	MASS (GRAMS)	MASS (GRAMS)	MASS (GRAMS)	MASS (GRAMS)
PAPI 2094		486.03	124.84	121.78	121.70	121.89	121.57
TMR-30		2.25	0.56	0.56	0.59	0.60	0.58
Polycat 8		0.94	0.23	0.24	0.23	0.23	0.24
DC 193		32.34	8.26	8.23	8.88	8.31	8.12
SUBTOTAL CONSTITUENTS		521.56	133.89	130.81	131.40	130.54	130.51
EPOXIES							
EPON 826							
EPON 8280			49.13	49.65	53.61	51.82	
EPON 826 +10% CTBN		259.07					
EPON 58005+10% CTBN				16.34			
EPON 58006+10% CTBN			16.34			65.05	
EPON 58034+10% CTBN							64.91
EPON 58042+10% CTBN					12.98	13.00	
SUBTOTAL EPOXY		259.07	65.47	65.99	66.59	65.05	64.91
TOTAL REACTANTS		780.63	199.36	196.80	197.99	195.59	195.42
FILLERS							
GMB A16/500							
GMB D32/4500		96.06	24.01	24.10	24.04	24.01	24.04
GMB K46							
Dicaperl HP 910							
Filite 300LF							

[0041] Mechanical test samples were prepared by coring 2 cm diameter cylinders from centers of molded, free-rise blocks of the foam. These cylinders were then cut to 3 cm lengths and the ends sanded flat and parallel to a final height of 2.5 cm. These test samples were then tested to failure under compressive loading at both room temperature and at about 200°C.

[0042] *Figures 7 and 8* are exemplary of the test response of a typical TEPIC body produced with a glass microsphere bulk filler. In particular, *Figure 7* shows the thermal expansion response of a specimen prepared from sample formulation #155 heated between room temperature and about 200°C. The calculated coefficient of thermal expansion ("CTE") for this sample was found to fall near the low end of the range of thermal expansion coefficients for most polyurethane foams (known to range from about 5 to about $10 \times 10^{-5} \text{ }^{\circ}\text{C}^{-1}$). It also was found that the CTE of the sample could be adjusted by manipulating the content and quantity of the bulk filler used. Applicants have produced a beta-eucryptite loaded TEPIC foam having a CTE of $2.8 \times 10^{-5} \text{ }^{\circ}\text{C}^{-1}$ in the temperature range of 25°C to 125°C, a value closely comparable to that of aluminum ($2.5 \times 10^{-5} \text{ }^{\circ}\text{C}^{-1}$).

[0043] *Figure 8* shows both the strain response of this same material when subjected to compression loading while heated at 200°C. The figure also shows the region over which the sample modulus was determined.

[0044] The data generated by the aforementioned mechanical tests is summarized below in *Tables 3 and 4*. As is clearly evident, the high temperature compression tests maintain significant strength showing only about a 30% to a less than a 50% fall-off in total compression strength at elevated temperatures relative to tests performed at room temperature. The polyisocyanurate foam of the present invention therefore, is seen to remain strong at elevated temperatures and pressures making the material suitable for a variety of useful purposes including, but not limited to composite "lay-up" tools, injection mold tools or inserts, inserts for forming mold cavities for metal castings, inserts for hot embossing, and the like.

TABLE 3 RESPONSE OF TEPIC SPECIMENS TESTED TO FAILURE UNDER A COMPRESSIVE LOAD AT ROOM TEMPERATURE.

SAMPLE NO.	DENSITY (g/cm ³)	FRACTURE STRESS (MPa)	MODULUS (GPa)
005	0.66	55.7	1.8
022	0.83	66.0	2.4
023	0.46	26.8	1.3
024B	0.48	19.2	1.0
025	0.82	67.1	2.4
038	0.58	38.2	1.4
039	0.55	33.5	1.3
041	0.59	40.4	1.6
042	0.58	26.3	0.8
155	0.63	50.8	1.7

TABLE 4 RESPONSE OF TEPIC TEST SPECIMENS TESTED TO FAILURE UNDER COMPRESSIVE LOADS AT 200°C.

SAMPLE NO.	DENSITY (g/cm ³)	FRACTURE STRESS AT 200°C (MPa)	STRENGTH LOSS (RELATIVE TO ROOM TEMPERATURE RESPONSE) (%)
005	0.66	29.8	46
022	0.83	39.5	40
023	0.46	15.1	44
039	0.55	23.6	30
041	0.59	26.9	33
042	0.58	18.2	31
155	0.63	34.1	33

[0045] Moreover, the composition also lends itself to methods for controlling the weight and/or the mechanical strength by forming parts as hollow shells, by casting the TEPIC foam *10* in a mold *20* wherein most of the interior volume is occupied by a mold insert *30* (see *Figure 9*). Furthermore, the range of working viscosities available with the composition allows a user to “spray-coat” or over-layer the pre-rise liquid onto large areas/surfaces (over a coated rough-cut polystyrene mold, for

instance) and to then machine the final exterior surface shape into the overcast layer.

[0046] Lastly, in those TEPIC formulations which incorporate a GMB filler, the materials also act as an effective insulator that may be applied directly, again by "spray-coating", or as cast, or a shaped "board".

[0047] Therefore, while the particular formulations devices as described herein are fully capable of attaining the objects of the invention, it is to be understood that 1) the formulations and devices are the presently preferred embodiments of the present invention and are thus representative of the subject matter which is broadly contemplated by the present invention; 2) the scope of the present invention is intended to encompass those other embodiments which may become obvious to those skilled in the art; and 3) the scope of the present invention is accordingly to be limited by nothing other than the appended claims. Furthermore, no element, component, or method step in the present disclosure is intended to be dedicated to the public regardless of whether the element, component, or method step is explicitly recited in the claims. No claim element herein is to be construed under the provisions of 35 U.S.C. §112, sixth paragraph, unless the element is expressly recited using the phrase "means for". Lastly, all material quantities and amounts are in parts by weight or by weight percentages, unless otherwise indicated.